

06-08-2006

RECOF



Docket No. XA-10579

103253214

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

6-5-06

1. Name of conveying party(ies)/Execution Date(s):
KOBAYASHI, Takashi
MINE, Toshiyuki

Execution Date(s): 05/25/2006
Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)
Name: Renesas Technology Corp.
Address: 4-1, Marunouchi 2-chome

City: Chiyoda-ku
State: Tokyo
Country: Japan Zip: _____

Additional name(s) & address(es) attached? Yes No

112950 U.S. PTO
11/446220



3. Nature of conveyance:
 Assignment Merger
 Security Agreement Change of Name
 Government Interest Assignment
 Executive Order 9424, Confirmatory License
 Other _____

4. Application or patent number(s): This document is being filed together with a new application.
A. Patent Application No.(s) _____
B. Patent No.(s) _____
Additional numbers attached? Yes No

5. Name and address to whom correspondence concerning document should be mailed:
Name: Mitchell W. Shapiro
Registration No.: 31,568
Address: Miles & Stockbridge P.C.
1751 Pinnacle Drive
Suite 500
City: McLean
State: Virginia Zip: 22102
Phone Number: 703-610-8652
Fax Number: 703/610-8686
Email Address: mwshapiro@milesstockbridge.com

6. Total number of applications and patents involved: 1
7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00
 Authorized to be charged to deposit account
 Enclosed - Any excess or insufficiency should be credited or debited to deposit account

8. Payment Information
a. Credit Card Last 4 Numbers _____
Expiration Date _____
b. Deposit Account Number 50-1165
Authorized User Name Mitchell W. Shapiro

9. Signature: Mitchell W. Shapiro
Name of Person Signing

Date June 5, 2006
Total Number of pages including cover sheet, attachments, and documents: 2

Documents to be recorded (including cover sheet) should be faxed to (703) 306-5995, or mailed to:
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O. Box 1450, Alexandria, VA 22313-1450

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ASSIGNMENT

(譲 渡 証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to Takashi KOBAYASHI and Toshiyuki MINE, Citizen(s) of Japan by Renesas Technology Corp., corporation(s) organized under the laws of Japan, located at 4-1, Marunouchi 2-chome, Chiyoda-ku, Tokyo, Japan, receipt of which is hereby acknowledged, we/I, the said Takashi KOBAYASHI and Toshiyuki MINE, do hereby sell and assign to said Renesas Technology Corp., their successors and assigns, all our right, title and interest, in and for the United States of America, in and to

SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD THEREOF

invented by us/me and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Renesas Technology Corp., their successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by us if this assignment and sale had not been made;

And we/I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of said above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And we/I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Renesas Technology Corp.

Signed on the date(s) indicated aside signatures:

INVENTOR(S)

(発明者フルネームサイン)

Date Signed

(署名日)

1) Takashi Kobayashi (Takashi KOBAYASHI)

5/25/2006

2) Toshiyuki Mine (Toshiyuki MINE)

5/25/2006

3) _____

4) _____

5) _____

6) _____

7) _____

8) _____
